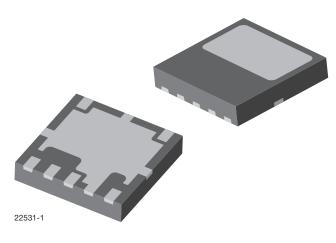
TSSP57038

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Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



click logo to get started.

DESIGN SUPPORT TOOLS



ORDERING CODE

Taping:

TSSP57038TT1 - top view taped TSSP57038TT2 - top view taped

FEATURES

- Up to 2 m for presence sensing
- Uses modulated bursts at 38 kHz
- 940 nm peak wavelength
- PIN diode and sensor IC in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The TSSP57038 is a compact infrared detector module for presence sensing applications. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

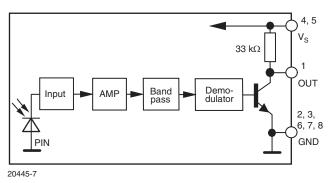
This component has not been qualified according to automotive specifications.

APPLICATIONS

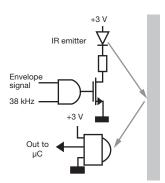
- Reflective sensors for hand dryers, towel or soap dispensers, water faucets, toilet flush
- Vending machine fall detection
- · Security and pet gates
- Person or object vicinity activation

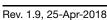
PARTS TABLE				
Carrier frequency	38 kHz	TSSP57038		
Package		Belobog		
Pinning		1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S		
Dimensions (mm)		3.95 W x 3.95 H x 0.8 D		
Mounting		SMD		
Application		Presence sensors		

BLOCK DIAGRAM



PRESENCE SENSING





1

Document Number: 82482

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





HALOGEN

GREEN

(5-2008)



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Supply voltage		VS	-0.3 to +6	V	
Supply current		I _S	5	mA	
Output voltage		Vo	-0.3 to (V _S + 0.3)	V	
Output current		Ι _Ο	5	mA	
Junction temperature		Tj	100	°C	
Storage temperature range		T _{stg}	-25 to +85	°C	
Operating temperature range		T _{amb}	-25 to +85	°C	
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW	

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

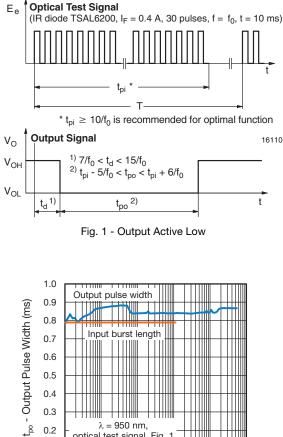
ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$E_v = 0, V_S = 5 V$	I _{SD}	0.55	0.7	0.9	mA
Supply current (piri 3)	$E_v = 40$ klx, sunlight	I _{SH}	-	0.8	-	mA
Supply voltage		VS	2.5	-	5.5	V
Transmission distance	E _v = 0, test signal see Fig. 1, IR diode TSAL6200, I _F = 400 mA	d	-	25	-	m
Output voltage low (pin 1)	I _{OSL} = 0.5 mA, E _e = 2 mW/m², test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t _{pi} - 5/f _o < t _{po} < t _{pi} + 6/f _o , test signal see Fig. 1	E _{e min.}	-	0.7	1.2	mW/m ²
Maximum irradiance	t _{pi} - 5/f _o < t _{po} < t _{pi} + 6/f _o , test signal see Fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	φ1/2	-	± 75	-	deg

TSSP57038



Vishay Semiconductors

TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)



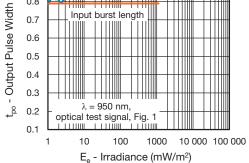


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

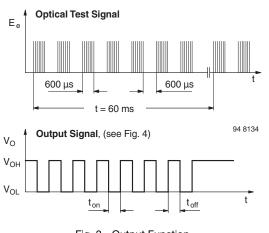


Fig. 3 - Output Function

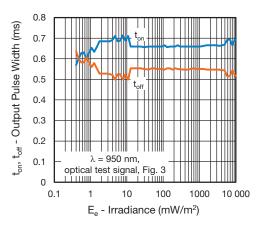


Fig. 4 - Output Pulse Diagram

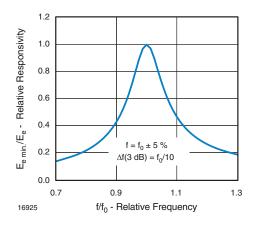


Fig. 5 - Frequency Dependence of Responsivity

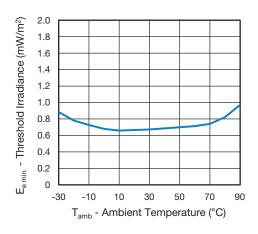


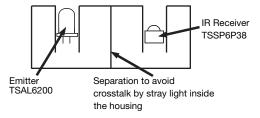
Fig. 6 - Sensitivity vs. Ambient Temperature

Rev. 1.9, 25-Apr-2018

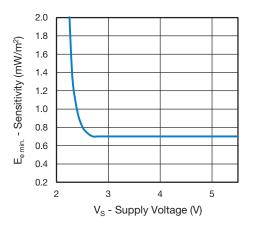


The typical application of this device is a reflective or beam break sensor with active low "detect" or "no detect" information contained in its output. Applications requiring up to 2 m beam break or 1 m reflective range benefit from the lower gain of these sensors because they are less sensitive to stray signal from the emitter, simplifying the mechanical design.

Example for a sensor hardware:



There should be no common window in front of the emitter and detector in order to avoid crosstalk via guided light through the window.



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Fig. 7 - Sensitivity vs. Supply Voltage

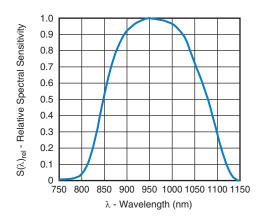


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

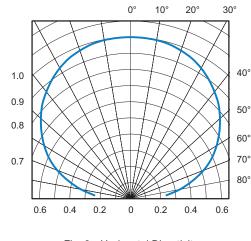


Fig. 9 - Horizontal Directivity

Rev. 1.9, 25-Apr-2018

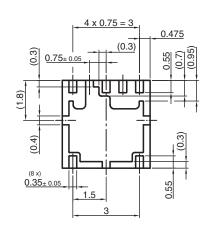
21947

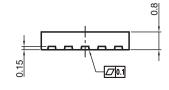
TSSP57038

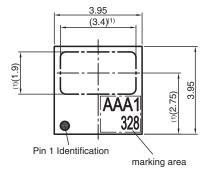


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PACKAGE DIMENSIONS in millimeters





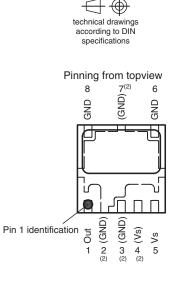


Drawing-No.: 6.550-5315.01-4 Issue: 2; 12.02.14

Notes

⁽¹⁾ Optically effective area

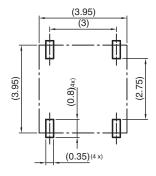
(2) Pins connected internally. It is not necessary to connect externally



Not indicated tolerances ± 0.1

F

Proposed pad layout from component side (dim. for reference only)



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ASSEMBLY INSTRUCTIONS

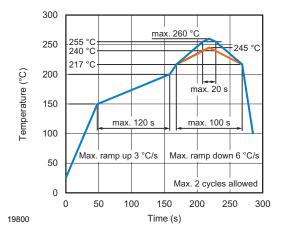
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

Manual Soldering

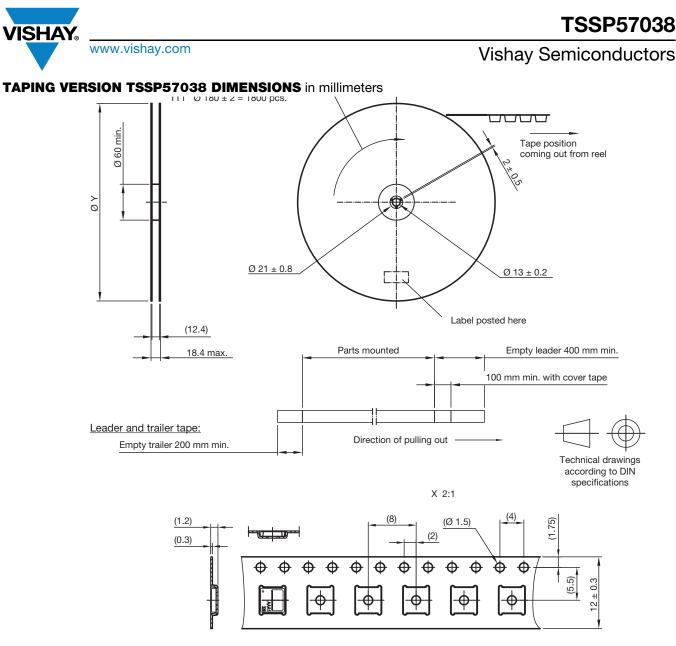
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



ORDERING INFORMATION				
ORDERING CODE	PACKAGING	VOLUME ⁽¹⁾	REMARKS	
TSSP57038TT1	Tapa and real	MOQ: 1800 pcs	3.95 mm x 3.95 mm x 0.75 mm	
TSSP57038TT2	Tape and reel	MOQ: 7000 pcs	3.95 mm x 3.95 mm x 0.75 mm	

Note

(1) MOQ: minimum order quantity



Drawing-No.: 9.700-5347.01-4 Issue: 2; 07.03.18 Not indicated tolerances ± 0.1



LABEL

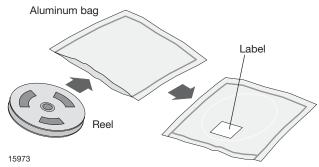
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
Long bar code top	Туре	Length
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	Х	3
Quantity	Ν	8
Total length	-	21
Short bar code bottom	Туре	Length
Selection-code	Х	3
Data-code	Ν	3
Batch-number	Х	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 3 label is included on all dry bags.

Rev. 1.9, 25-Apr-2018



LEVEL Caution 3 This bag contains MOISTURE-SENSITIVE DEVICES 1. Calculated shelf life in sealed bag: 12 months at ${<}40^\circ C$ and ${<}90\%$ relative humidity (RH) 2. Peak package body temperature: 260°C 3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be a) Mounted within: $\underbrace{168}_{lf \, blank, \, see \, adjacent \, bar \, code \, label}_{down C/60\% \, RH, \, or}$ b) Stored per J-STD-033 4. Devices require bake, before mounting, if: a) Humidity Indicator Card reads >10% for level 2a - 5a devices or $>\!\!60\%$ for level 2 devices when read at $23{\pm}5^{\circ}C$ b) 3a or 3b are not met 5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure Bag Seal Date: If blank, see adjacent bar code label Note: Level and body temperature defined by IPC/JEDEC J-STD-020 22650

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

Vishay Semiconductors

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)





Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Туре
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead: quantity per reel:
 TT, top view package, 1190 pcs
 TR, side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 TT, top view package, 2200 pcs
 TR, side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel: WTT, top view package, 2200 pcs WTR, side view package, 2300 pcs
- D. Belobog: quantity per reel: TT1, top view package, 1800 pcs
- E. Belobog with shield: quantity per reel: TT1, top view package, 1500 pcs
- F. Minimold DF1P: quantity per reel: DF1P, 1100 pcs
- G. TVCastSMD TR1: quantity per reel: TR1, side view package, 2000 pcs

ORDER DESIGNATION

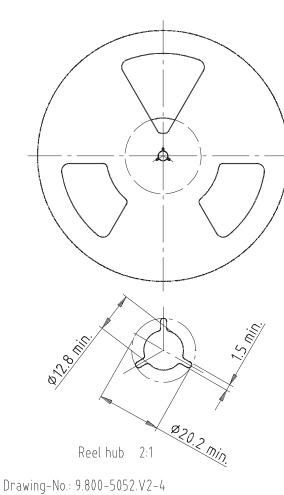
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing) TSOP75238TR (reel packing) TSOP75338WTT (reel packing) TSOP57438TT1 (reel packing) TSOP57238HTT1 (reel packing) TSOP39438TR1 (reel packing)



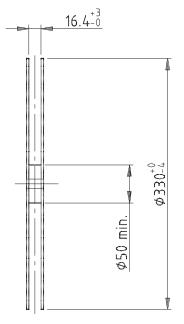
REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



Issue: 1; 07.05.02

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



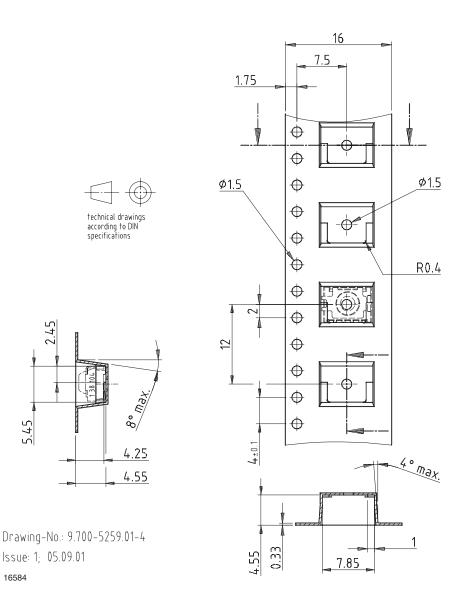
technical drawings according to DIN specifications

Rev. 2.5, 08-Mar-18



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT, TSOP16...TT, TSOP96...TT)

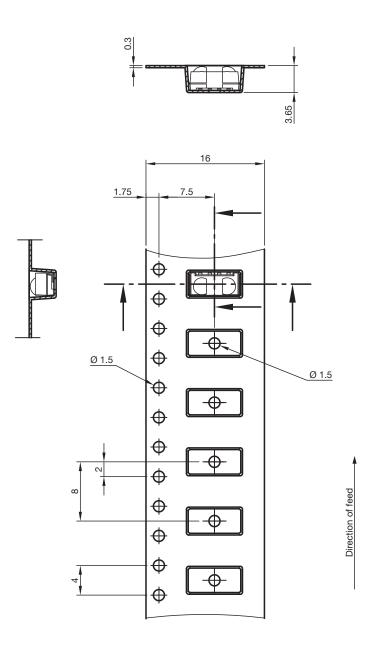


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TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT, TSOP15...TT, TSOP95...TT)





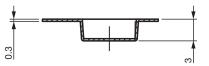
technical drawings according to DIN specifications

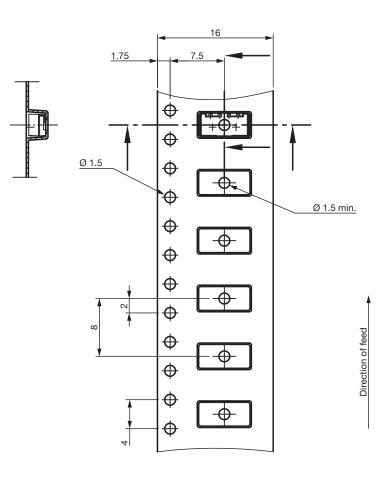
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT, TSOP15...WTT, TSOP95...WTT)







technical drawings according to DIN specifications

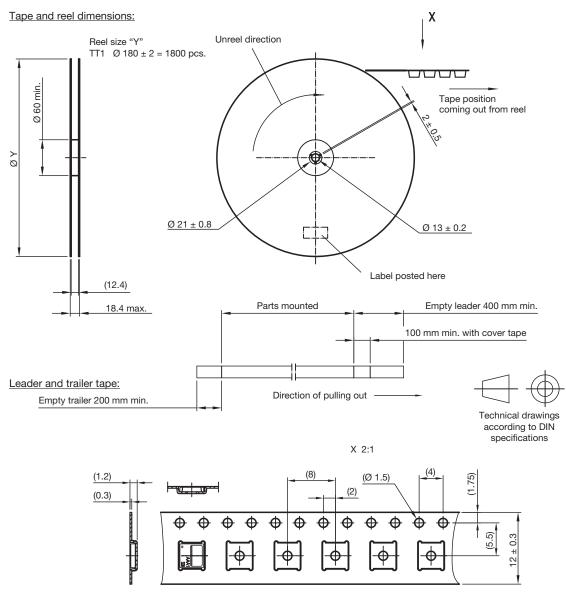
Drawing-No.: 9.700-5341.01-4 Issue: 3; 06.10.15

TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP57...TT1, TSOP17...TT1, TSOP97...TT1)

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'ISHA)



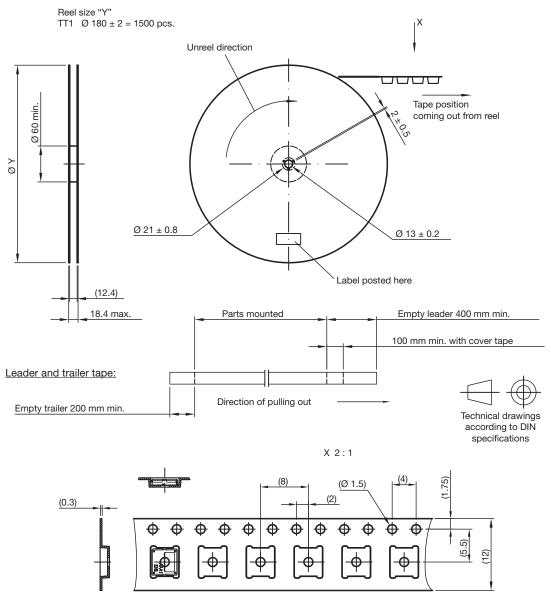
Drawing-No.: 9.700-5347.01-4 Issue: 2; 07.03.18 Not indicated tolerances ± 0.1



TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP57...HTT1, TSOP17...HTT1, TSOP97...HTT1)

Tape and reel dimensions:



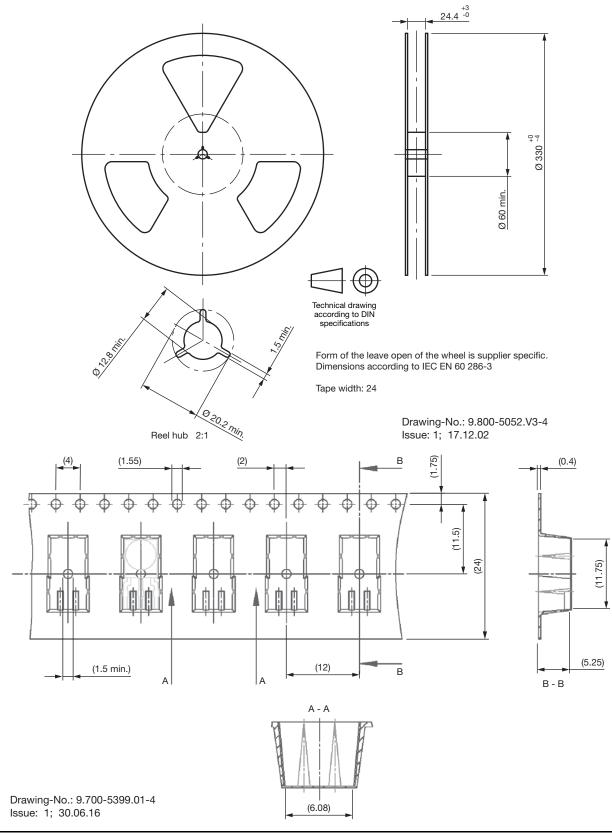
Drawing-No.: 9.700-5380.01-4 Issue: 3; 07.03.18 Not indicated tolerances $\pm \ 0.1$

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TAPING VERSION TSOP...DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P, TSOP13...DF1P, TSOP93...DF1P)



Rev. 2.5, 08-Mar-18

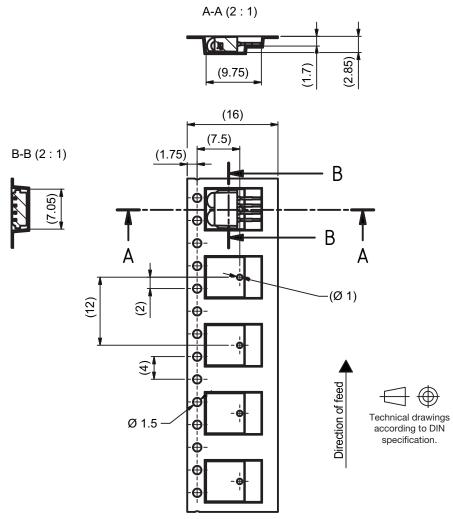
8

Document Number: 80125



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR1 (TSOP59...TR1, TSOP39...TR1, TSOP19...TR1, TSOP99...TR1)

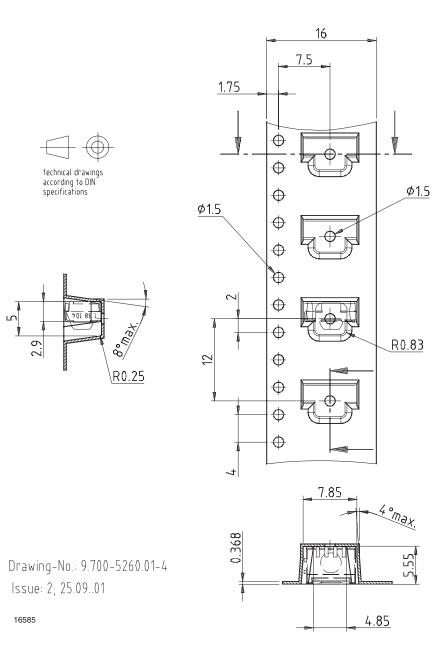


Drawing-No.: GO-100220.10_Z Issue B: 08.02.17

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR, TSOP16...TR, TSOP96...TR)

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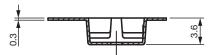


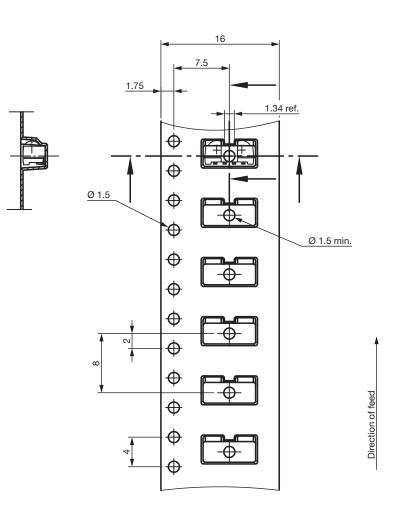
VISHAY



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSSP7...., TSOP75...TR, TSOP77...TR, TSSP7....TR, TSOP15...TR, TSOP95...TR)





 $\ominus \oplus$

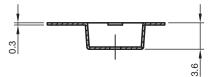
technical drawings according to DIN specifications

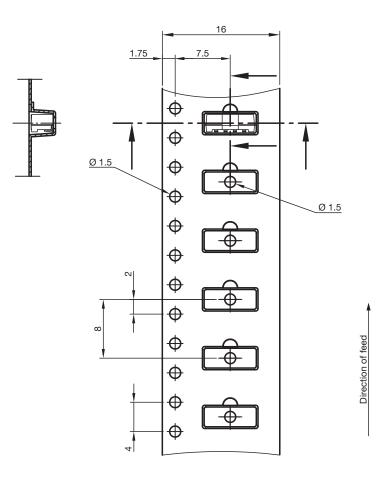
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR, TSOP15...WTR, TSOP95...WTR)





 $\ominus \oplus$

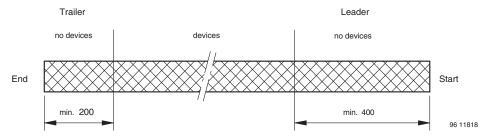
technical drawings according to DIN specifications

Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13





LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

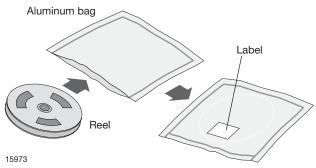
VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)				
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	XXXXXXX+	Company logo		
LONG BAR CODE TOP	ТҮРЕ	LENGTH		
Item-number	Ν	8		
Plant-code	Ν	2		
Sequence-number	Х	3		
Quantity	Ν	8		
Total length	-	21		
SHORT BAR CODE TOP	ТҮРЕ	LENGTH		
Selection-code	Х	3		
Data-code	Ν	3		
Batch-number	Х	10		
Filter	-	1		
Total length	-	17		

Rev. 2.5, 08-Mar-18



DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

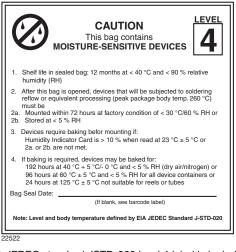
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard JSTD-020 level 4 label is included on all dry bags.

OUTER PACKAGING

The sealed reel is packed into a pizza box.

Vishay Semiconductors



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

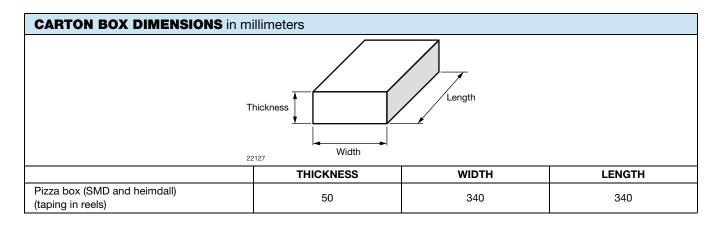
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





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Vishay

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